

# A Physicist's First Year in Industry

Taylor Byrum

2/27/2017

# My path to Texas Instruments



2006



2010



2016

2008



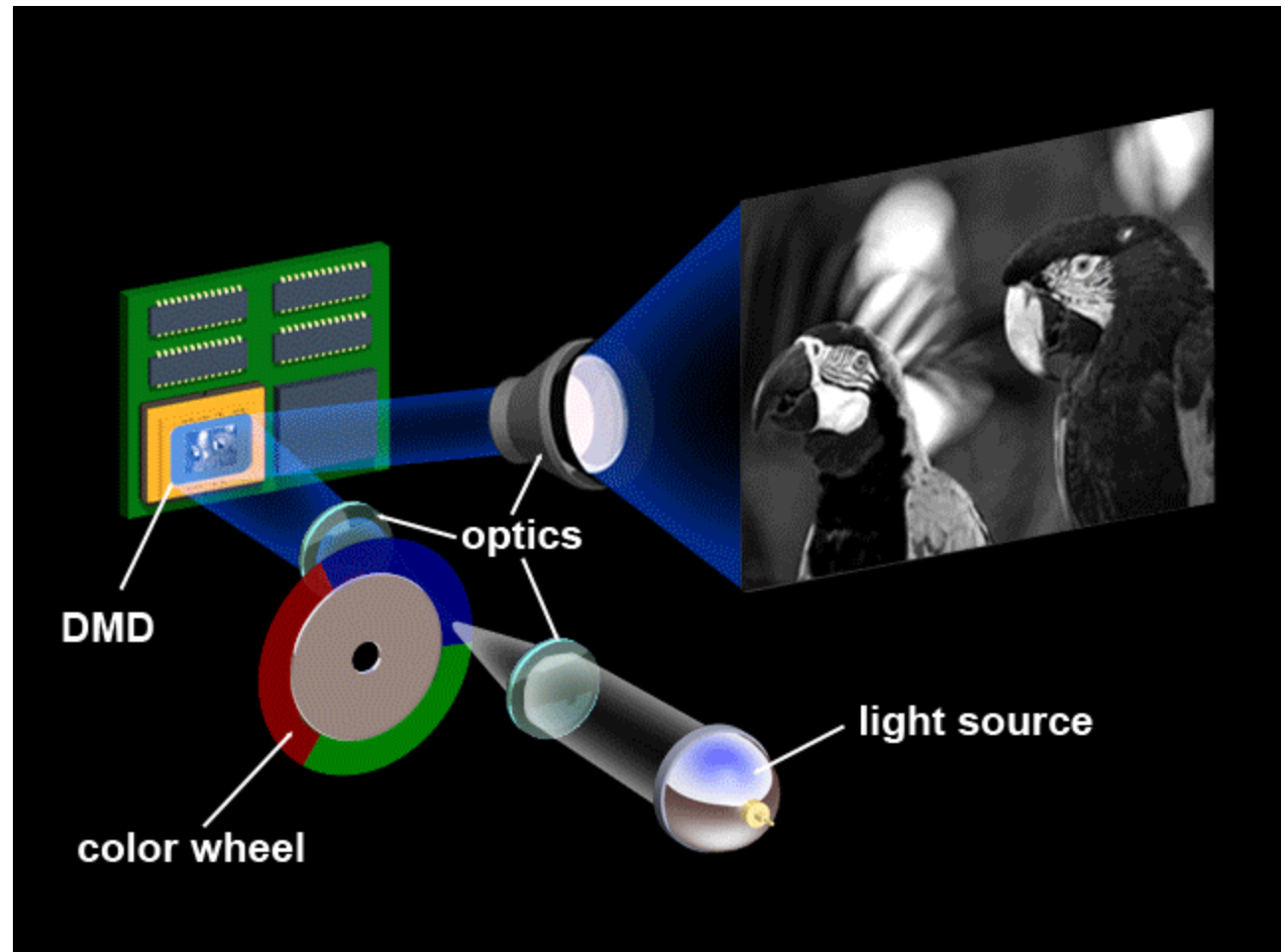
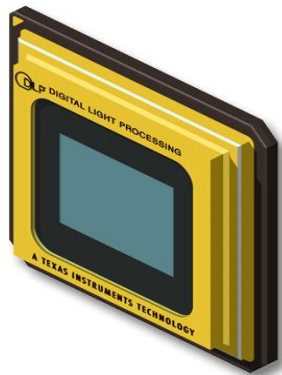
2015



[http://physics.illinois.edu/careers-seminar/UIUC\\_Physics\\_Career\\_Seminar\\_Byrum.pdf](http://physics.illinois.edu/careers-seminar/UIUC_Physics_Career_Seminar_Byrum.pdf)

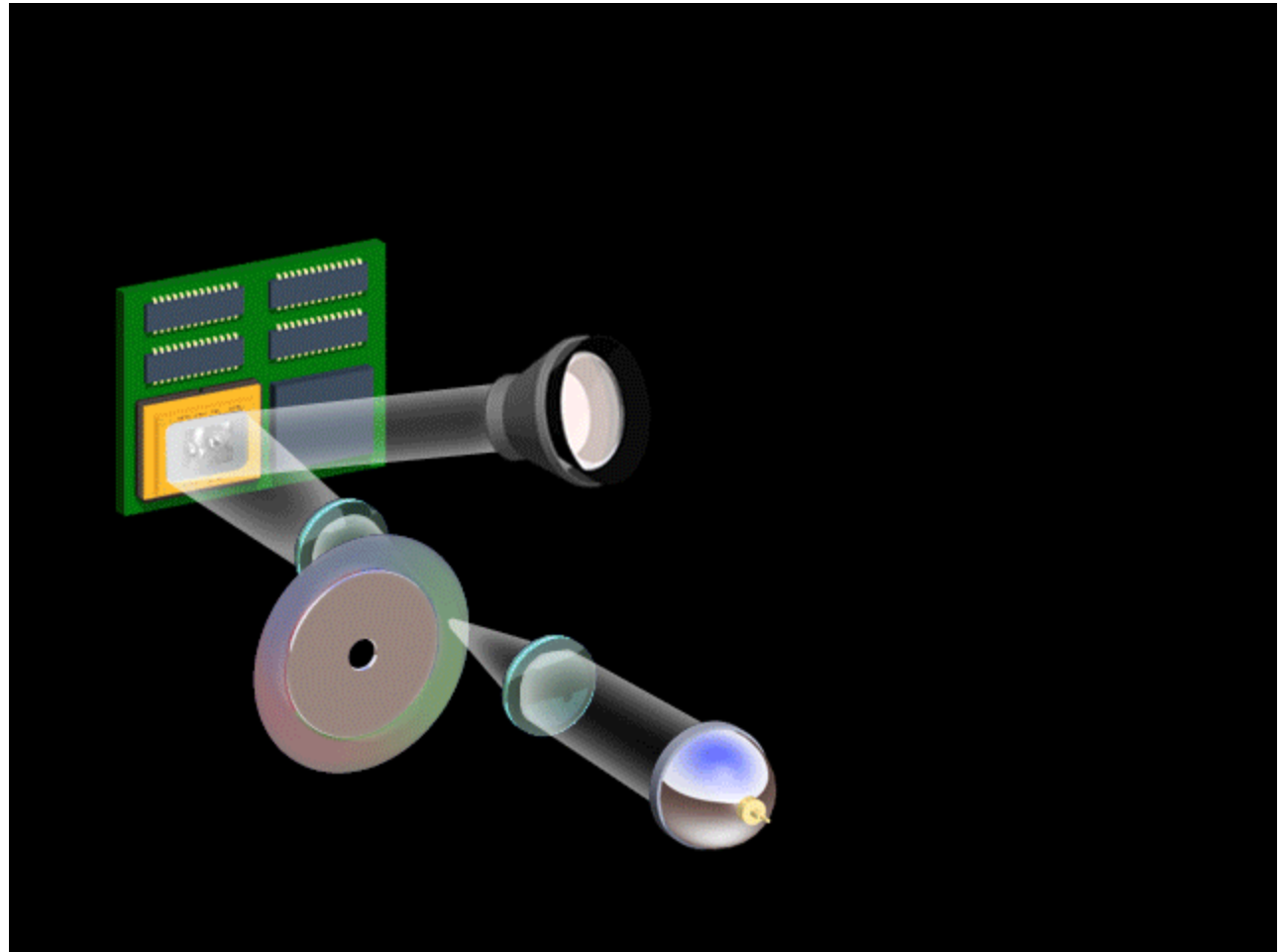
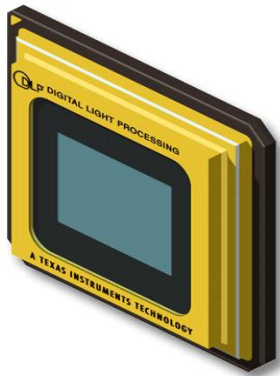
# DLP® Technology

Digital Micromirror Device (DMD)



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## **MEMS device**

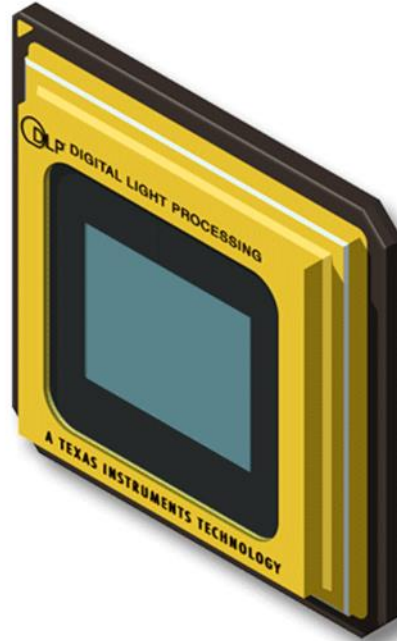
Invented by solid state physicist Larry Hornbeck

## **Number of mirrors**

150,000 to >4,000,000

## **Mechanical elements**

Aluminum



## **Mechanical motion**

Makes discrete contacts or landings

## **Address voltage**

3.3-volt CMOS technology

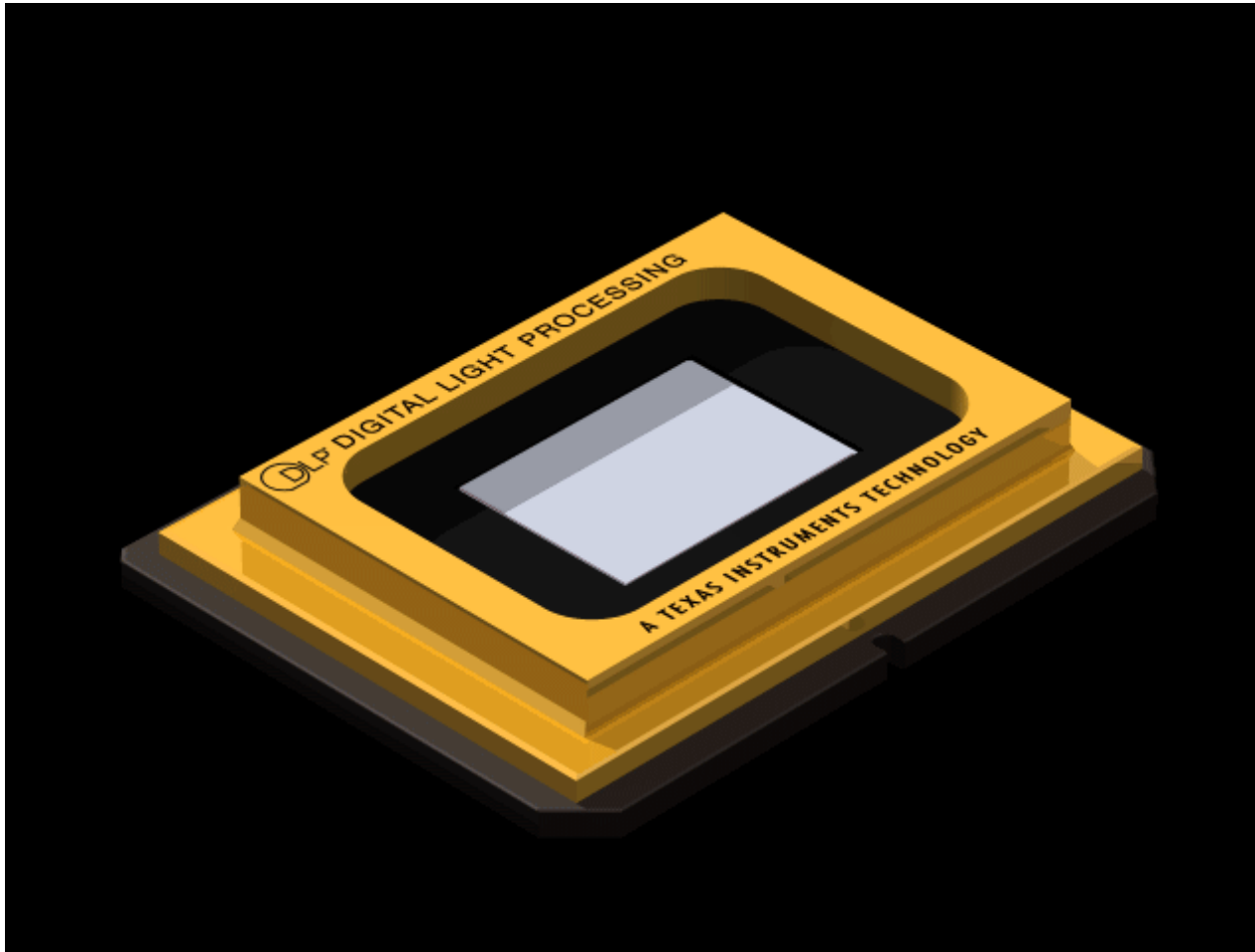
## **Lifetime**

up to 100,000 hrs

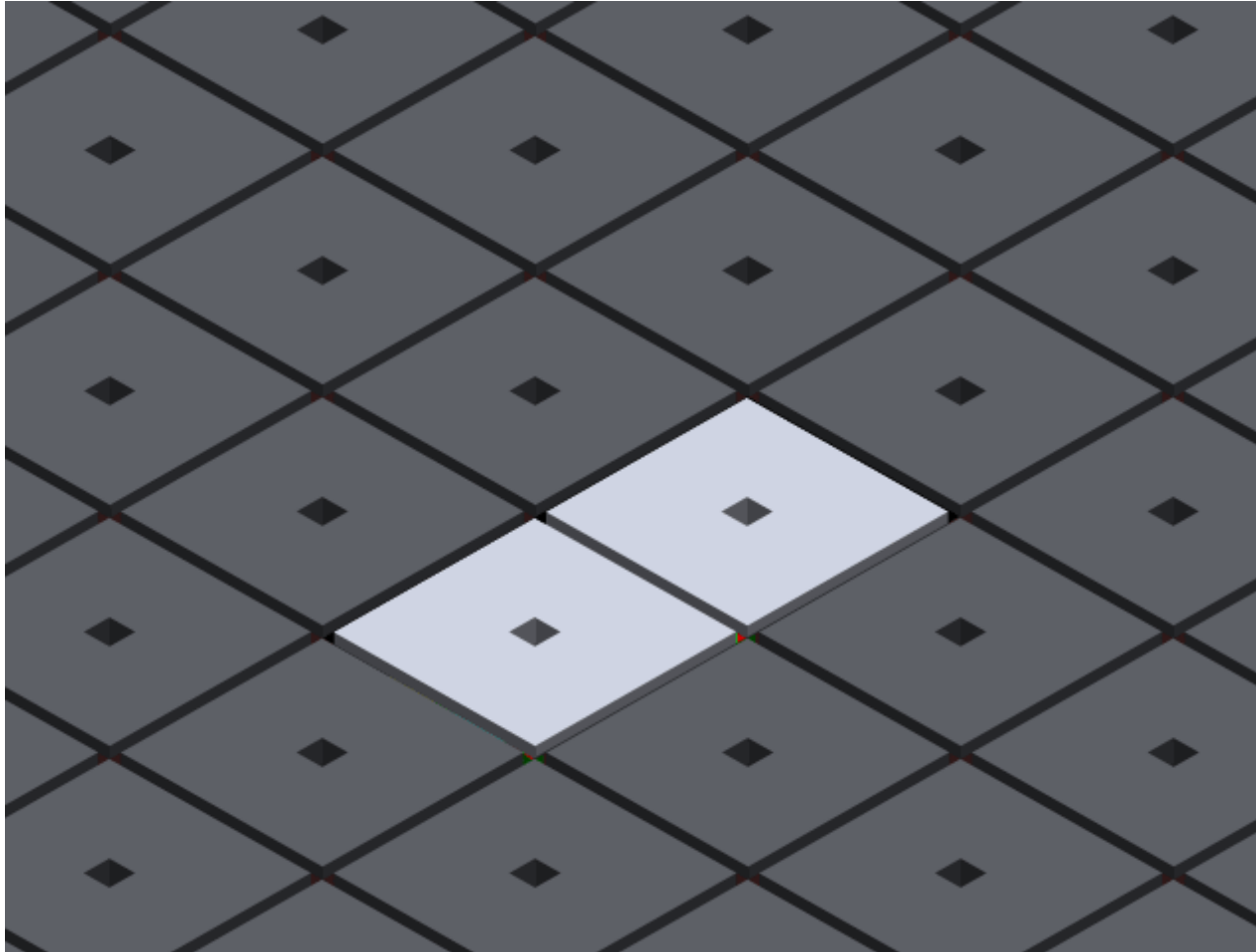
## **Process**

Low temperature, sputter deposition, plasma etch (standard SC processes)

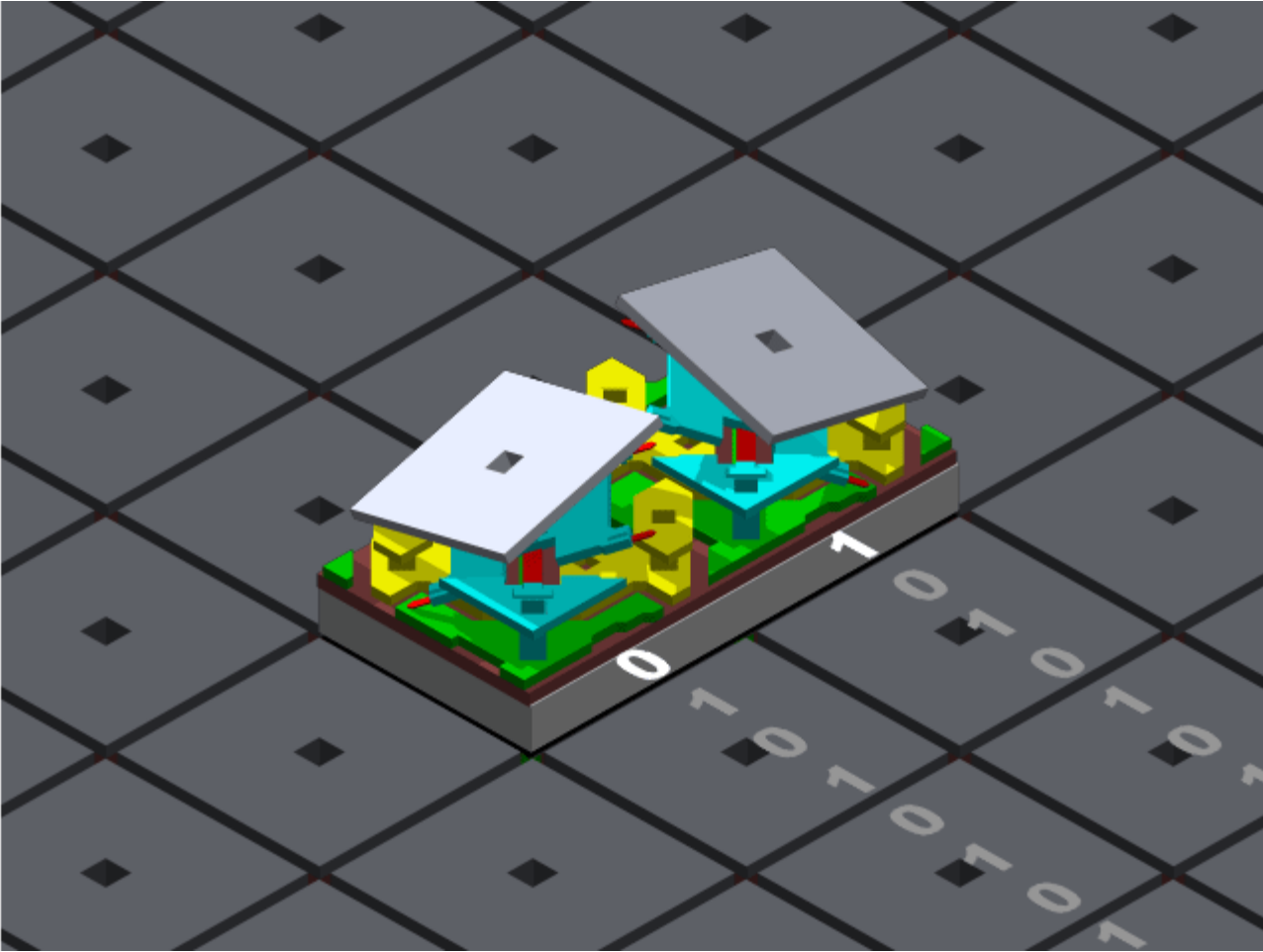
# How DLP technology works



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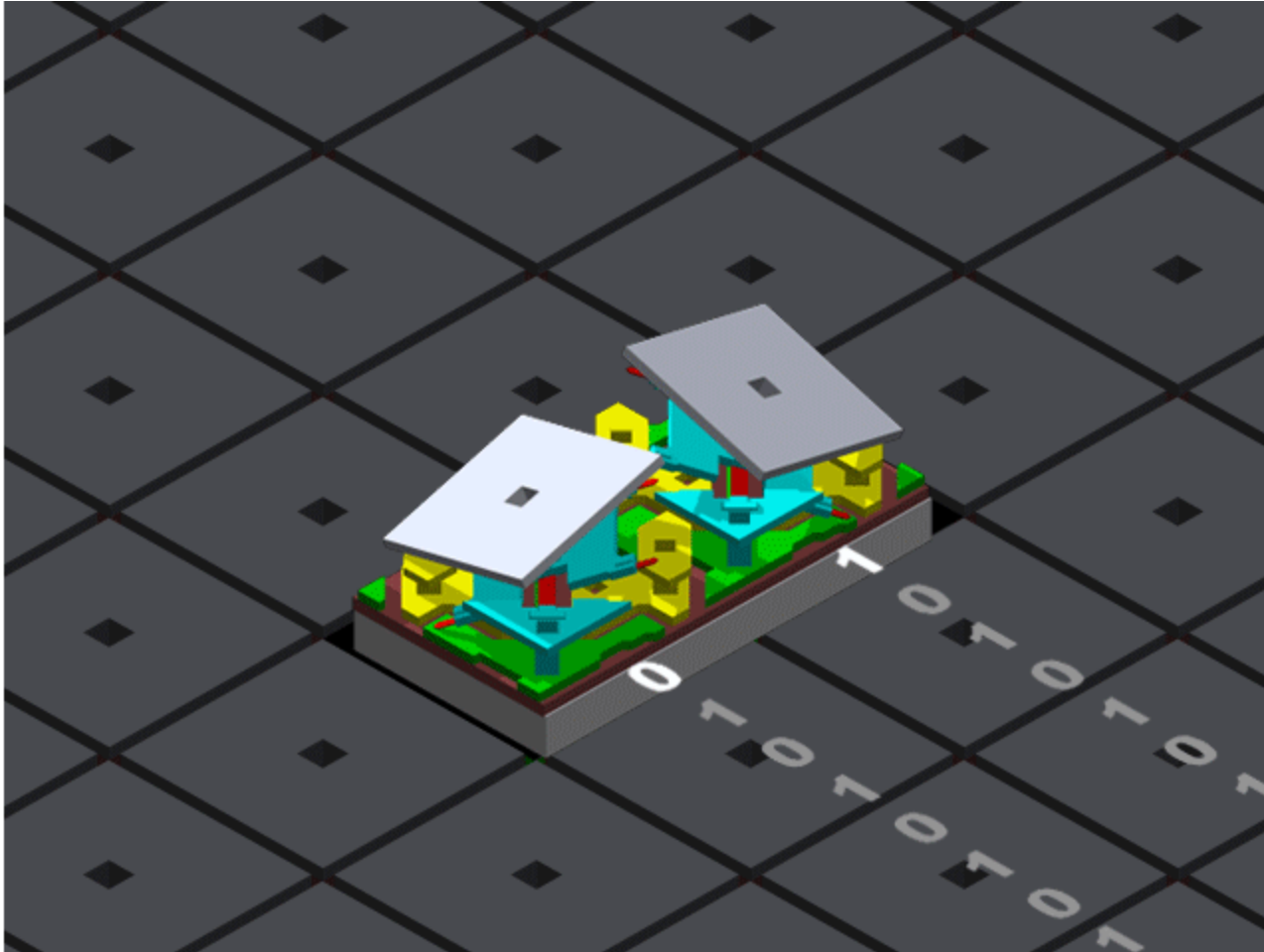


# How DLP technology works



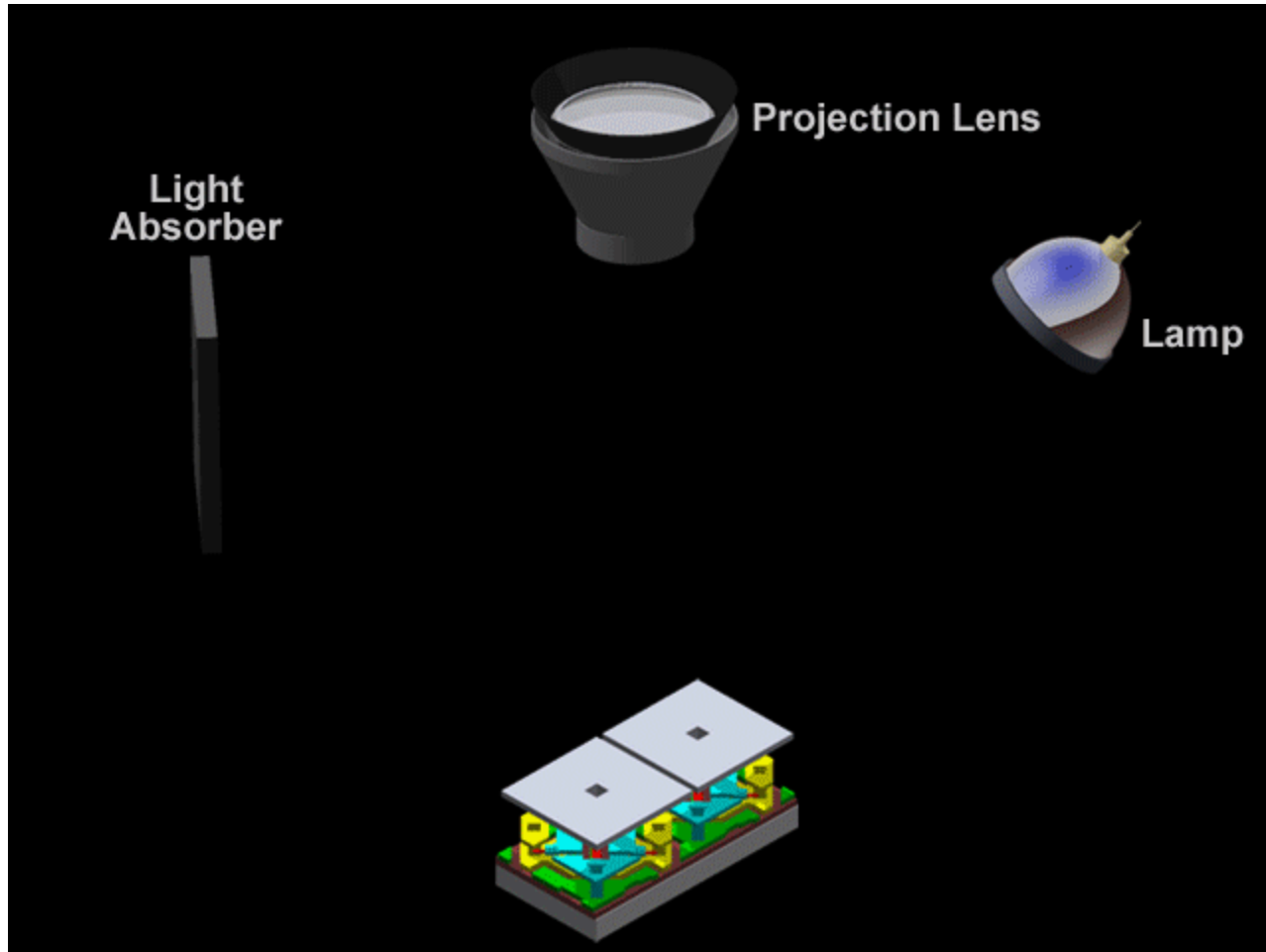


# How DLP technology works

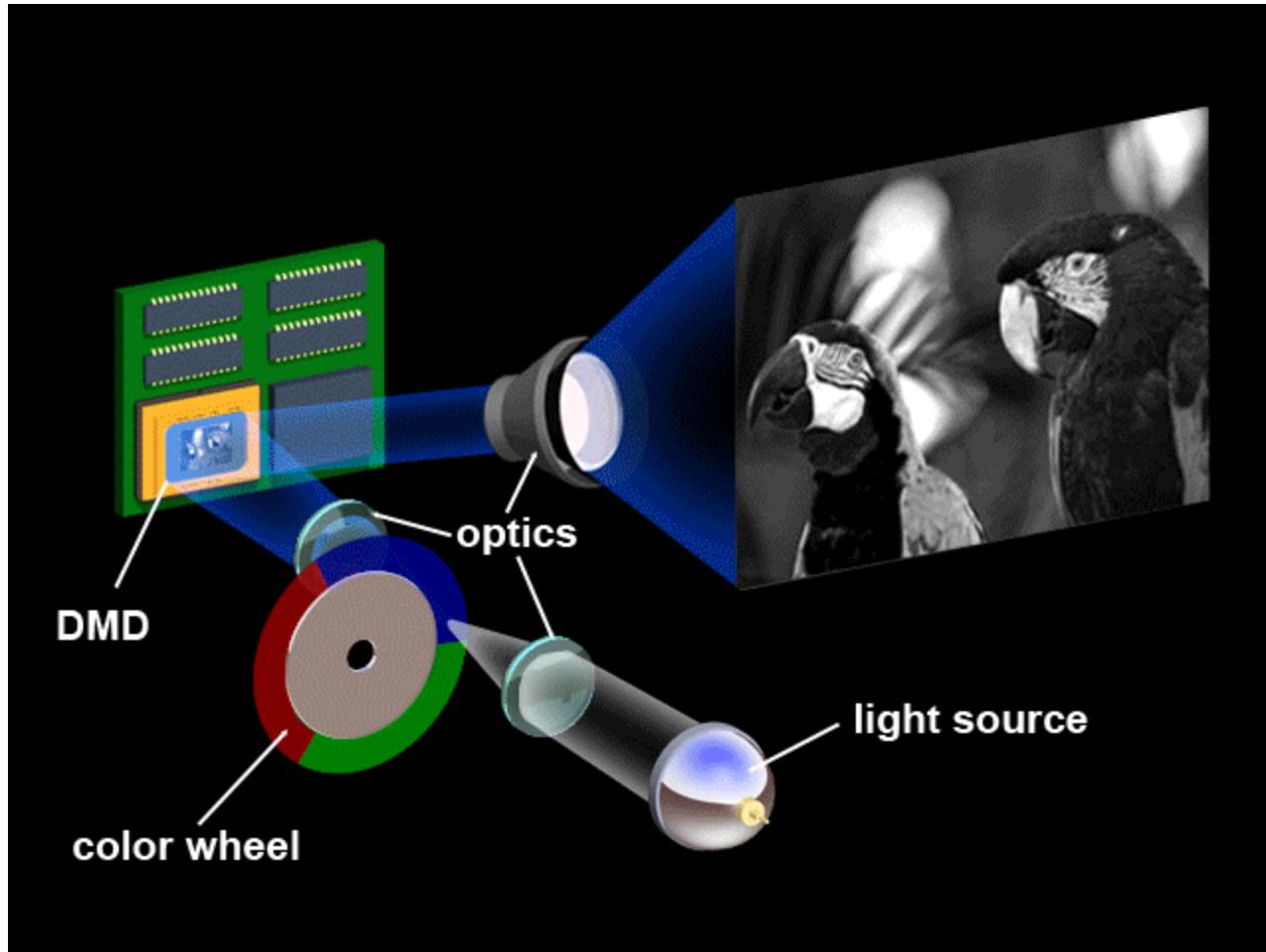




# How DLP technology works

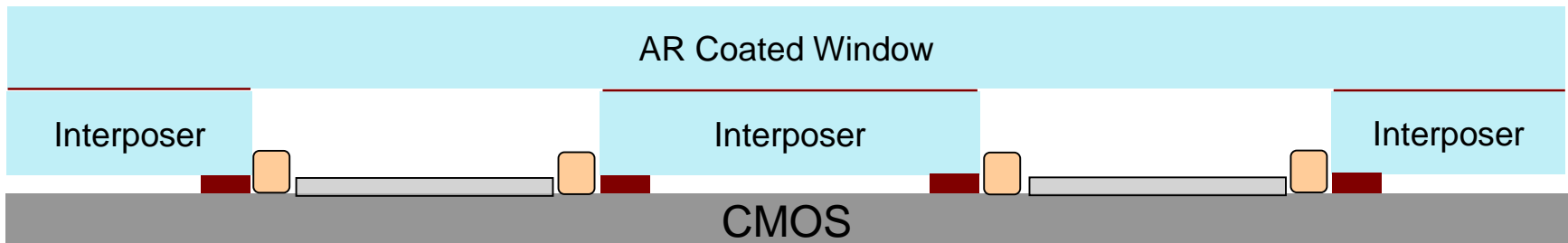


# How DLP technology works



# What I work on

- Process development engineer
  - Stiction (static friction)
- Projects
  - “Fundamental understanding” of headspace
  - Wafer-level packaging
  - New applications



# Benefits of Physics PhD – Example

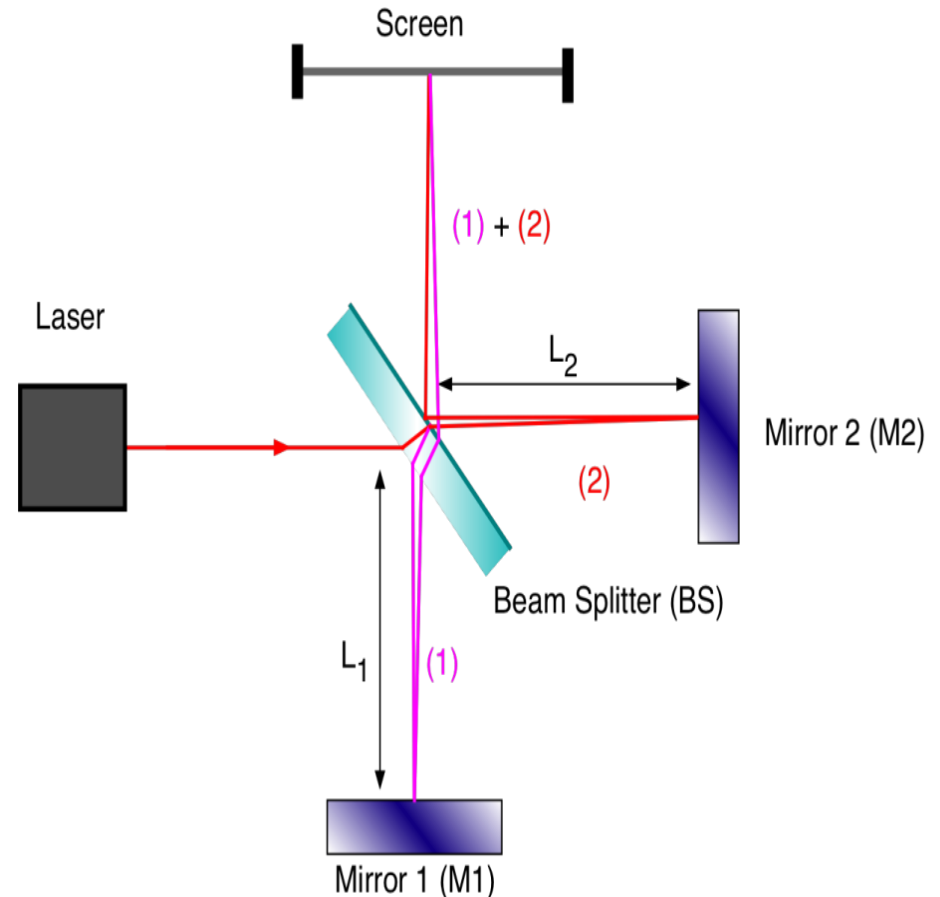
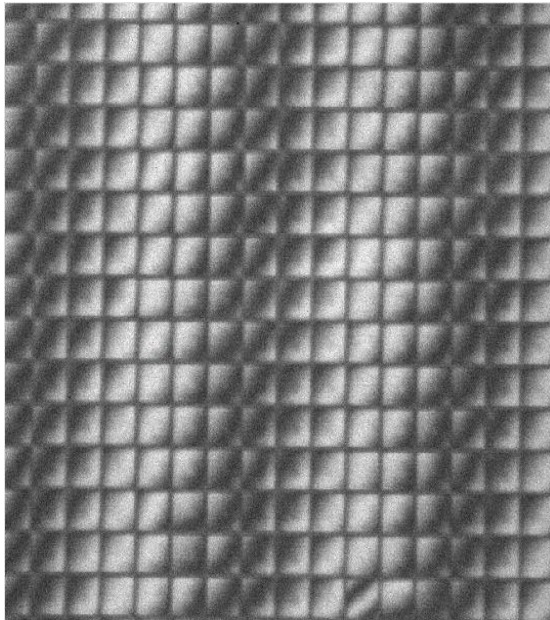
- Problem: Ongoing moisture permeation problem with specific device.
  - Abnormally large distribution of moisture in package.
- Hypothesis: Poor UV curing of epoxy at bondlines, resulting in excessive moisture permeation.
  - No clear reason why these devices had uncured epoxy while epoxy in other devices was cured.
- While working on another project, I noticed peculiarities in the interferometric measurements on these devices.
  - These peculiarities had been observed by others but had been disregarded.

The following slides are from a presentation I gave shortly after I started this job.

# Interferometry peculiarities observed

**Observation #1:** All dies from a single wafer showed very similar modulation % values of either 30-40% or 10-20%.

**Observation #2:** Modulation % values changed between some wafers.

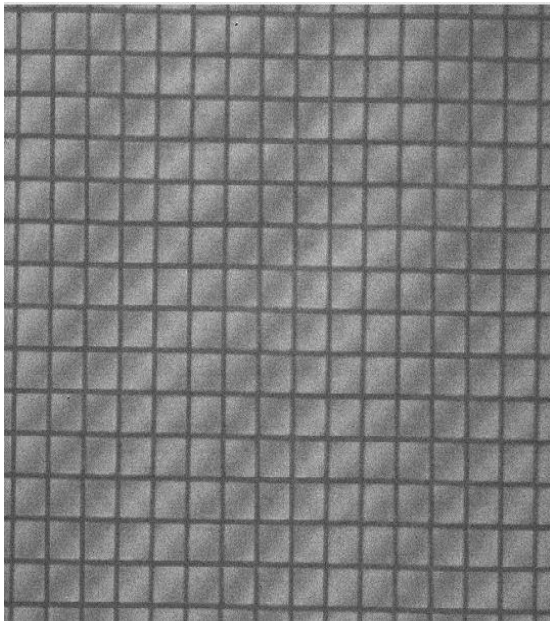


# Modulation %

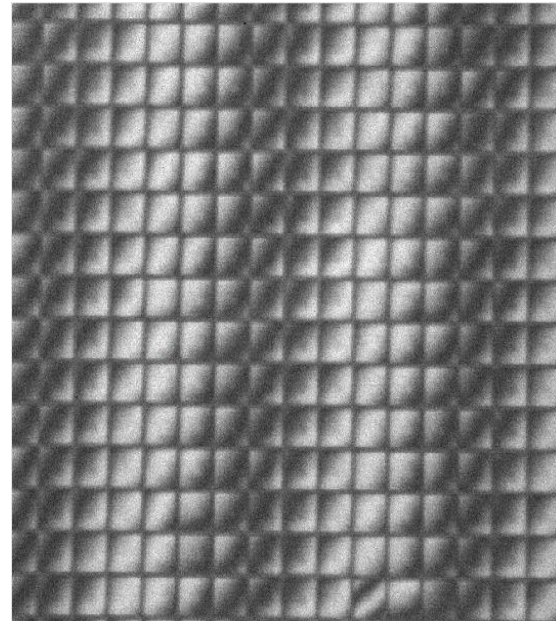
Modulation % is like a contrast ratio of the fringes.

- 10-20% is “bad”, data is swamped by noise.
- 30-40% is “good”, data quality looks good.

Modulation 14%



Modulation 40%

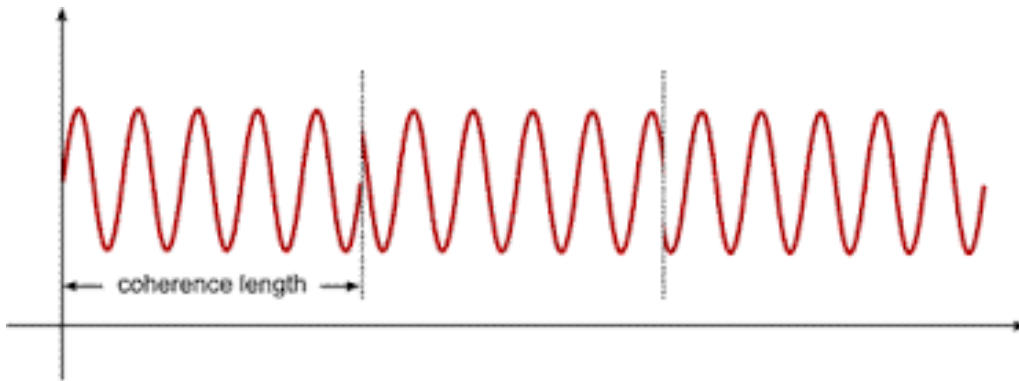




# Understanding modulation %

## Interferometry Basics

- Interference pattern (fringes) requires coherence length to be greater than optical path length difference between splits beams.
  - Optical path length (OPL) = (index of refraction of medium)\*(length of travel)
  - In this case, light source is blue LED and has CL = 4.7 microns.
- Ideally, the split beams should have the same intensity when they recombine.
  - Modulation % is maximized for equally intense beams.



$$\begin{aligned} E_{\text{TOTAL}}^2 &= (E_1 + E_2)^2 \\ &= E_1^2 + E_2^2 + 2E_1 \cdot E_2 \end{aligned}$$

# What could cause modulation % variations?

## OPL Differences

- Window thickness
- Index of refraction

## Relative Beam Intensities

- Transmissions due to AR coating differences
- Window thickness
- ~~Reflectivity of the mirror array\*~~

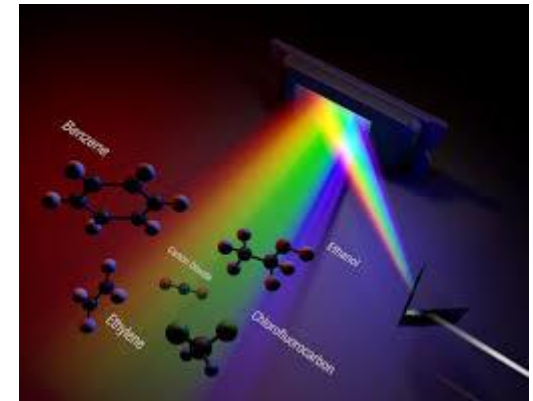
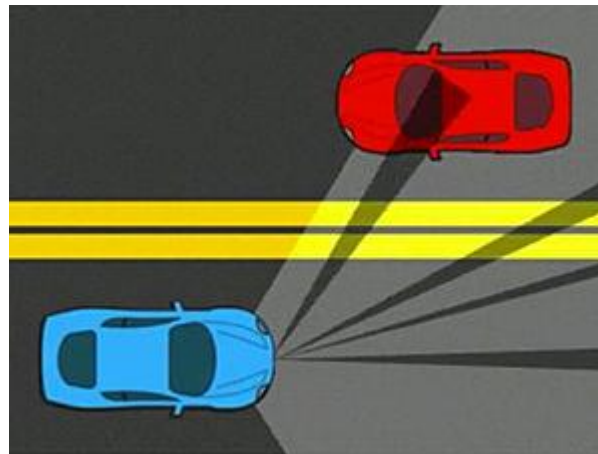
Further experiments showed that windows from supplier had two distinct flavors, which had subtle differences in both window thickness and AR coating transmission properties.

- Window thickness differences likely accounted for what I observed.
- Transmission properties accounted for poor UV curing of epoxy.

\*Ruled out by experiment where I swapped the windows

# What I like about my job

- Interdisciplinary
- Team environment
  - Work alongside some other PhDs from different fields, but mainly surrounded by BSs in mechanical and electrical engineering
- Mature technology, but impacts can still be made
- Work stays at work
- Cool technology with interesting applications still to come



# Final words

- My advice for getting a job in industry:
  - Make a contact with someone in the company (networking)
  - Show interest/passion for the position or technology
- If you're worried about early job performance like I was:
  - You'll learn the job on the job
  - They hired you knowing you currently are not an expert
- Feel free to connect with me on LinkedIn or e-mail me at [t-byrum@ti.com](mailto:t-byrum@ti.com)

Thank you!